TE Internal #: 1746854-1

PCB Spring Contact, Preloaded - C-Clip, Side Protected,

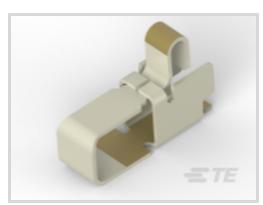
Uncompressed Height 2.4 mm [.094 in], Length .138 in [3.5 mm],

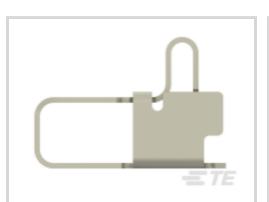
Width 1.1 mm [.043 in]

View on TE.com >



Connectors > PCB Connectors > Board-to-Board Connectors > PCB Spring Contacts











Spring Finger Type: Preloaded - C-Clip

Scalable: No

Side Protected: Yes

Uncompressed Height: 2.4 mm [.094 in]

Contact Length: 3.5 mm [ .138 in ]

## **Features**

## Product Type Features

Spring Finger Type	Preloaded - C-Clip
Scalable	No
Connector System	Board-to-Board
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board

## **Configuration Features**

Side Protected	Yes
Number of Positions	1

### **Contact Features**

Contact Underplating Material	Nickel
PCB Contact Termination Area Plating Material	Gold
Contact Base Material	Copper Alloy
Contact Length	3.5 mm[.138 in]
Contact Width	1.1 mm[.043 in]



Contact Working Range (Low)	1.6 mm[.063 in]
Contact Working Range (High)	2 mm[.079 in]
Point of Contact Area Plating Material	Gold
Contact Current Rating (Max)	1 A
Dimensions	
Uncompressed Height	2.4 mm[.094 in]
Usage Conditions	
Operating Temperature Range	-40 - 85 °C[-40 - 185 °F]
Operation/Application	
Circuit Application	Signal
Packaging Features	
Packaging Quantity	5000
Packaging Method	Tape & Reel

## **Product Compliance**

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2022 (224) Candidate List Declared Against: JAN 2022 (223) SVHC > Threshold: Not Yet Reviewed
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Reflow solder capable to 260°C

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides

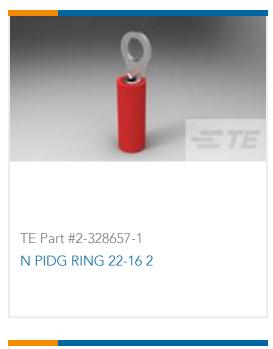


on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

# Compatible Parts



# Customers Also Bought







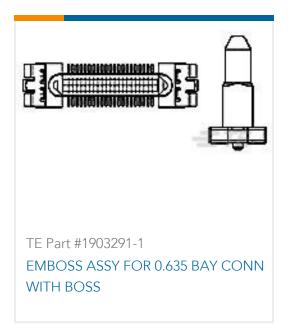












# **Documents**

Product Drawings
SHILED FINGER 2411 ANTI OVER S

English



#### **CAD Files**

3D PDF

3D

**Customer View Model** 

ENG\_CVM\_CVM\_1746854-1\_D.2d\_dxf.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_1746854-1\_D.3d\_igs.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_1746854-1\_D.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use

## Datasheets & Catalog Pages

Spring Fingers Quick Reference Guide

English

## **Product Specifications**

**Product Specification** 

Japanese

### **Product Environmental Compliance**

MD\_1746854-1\_022620182254\_dmtec

English

MD\_1746854-1\_022620182254\_dmtec

English